

N+P Channel Power MOSFET

Features

- N-Channel

$V_{DS} = 60V, I_D = 8.0A$

$R_{DS(ON)} @V_{GS} = 10V, TYP 32m\Omega$

$R_{DS(ON)} @V_{GS} = 4.5V, TYP 39m\Omega$

- P-Channel

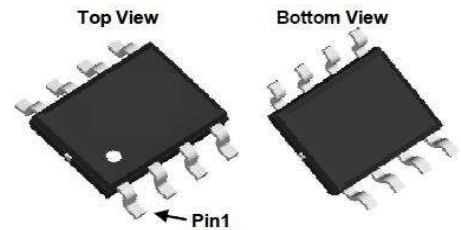
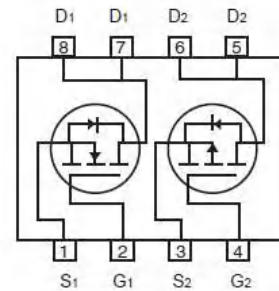
$V_{DS} = -60V, I_D = -6.0A$

$R_{DS(ON)} @V_{GS} = 10V, TYP 52m\Omega$

$R_{DS(ON)} @V_{GS} = 4.5V, TYP 65m\Omega$

General Description

- Motor Control
- Synchronous Rectification
- Halogen-free



Package Marking and Ordering Information

Device Marking	Device	Device Package	Packaging Code	Reel Size	Quantity (PCS)
4688	RM4688S8	SOP-8	-W	13inch	4000

Absolute Maximum Ratings @ $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V_{DSS}	60	-60	V	
Gate-Source Voltage	V_{GSS}	± 20	± 20	V	
Drain Current (Continuous) *AC	I_D	$T_A=25^\circ C$	8.0	-6.0	A
		$T_A=70^\circ C$	6.5	-4.5	
Drain Current (Pulse) *B	I_{DM}	15	-12	A	
Power Dissipation	P_D	3		W	
Operating Temperature/ Storage Temperature	T_J/T_{STG}	-55~150		$^\circ C$	

Thermal Resistance Ratings

Parameter	Symbol	Maximum	Unit
Maximum Junction-to-Ambient	R_{thJA}	62.5	$^\circ C/W$

N-Channel Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	60	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 48V, V_{GS} = 0V$	--	--	1	μA
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_{DS} = 250\mu A$	1	1.6	3	V
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	--	--	± 100	nA
Drain-Source On-state Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 4.5A$	--	32	50	m Ω
	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 3.5A$	--	39	60	m Ω
Forward Transconductance	g_{FS}	$V_{DS} = 10V, I_D = 4A$	2	--	--	S
Diode Forward Voltage	V_{SD}	$I_{SD} = 2A, V_{GS} = 0V$	--	--	1.2	V
Diode Forward Current	I_S	$T_C = 25^\circ\text{C}$	--	--	4.5	A
Switching						
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DS} = 30V, I_D = 4.5A$	--	13	--	nC
Gate-Source Charge	Q_{gs}		--	1.7	--	nC
Gate-Drain Charge	Q_{gd}		--	2.6	--	nC
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 30V, V_{GS} = 10V, I_D = 1A,$ $R_{GEN} = 6\Omega$	--	11	--	ns
Turn-on Rise Time	t_r		--	3	--	ns
Turn-off Delay Time	$t_{d(off)}$		--	30	--	ns
Turn-Off Fall Time	t_f		--	3	--	ns
Dynamic						
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0\text{MHz}$	--	670	--	pF
Output Capacitance	C_{oss}		--	80	--	pF
Reverse Transfer Capacitance	C_{rss}		--	45	--	pF

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C: The current rating is based on the $t \leq 10\text{s}$ junction to ambient thermal resistance rating.

P-Channel Electrical Characteristics @ $T_A=25^{\circ}\text{C}$ unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-60	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -48V, V_{GS} = 0V$	--	--	-1	μA
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_{DS} = -250\mu A$	-1	-1.6	-3	V
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	--	--	± 100	nA
Drain-Source On-state Resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -4.5A$	--	52	65	m Ω
	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -3.8A$	--	65	75	m Ω
Forward Transconductance	g_{FS}	$V_{DS} = -10V, I_D = -3.1A$	2	--	--	S
Diode Forward Voltage	V_{SD}	$I_{SD} = -1A, V_{GS} = 0V$	--	--	-1.2	V
Diode Forward Current	I_S	$T_C = 25^{\circ}\text{C}$	--	--	-3.5	A
Switching						
Total Gate Charge	Q_g	$V_{GS} = -10V, V_{DS} = -30V, I_D = -3.5A$	--	11	--	nC
Gate-Source Charge	Q_{gs}		--	2.4	--	nC
Gate-Drain Charge	Q_{gd}		--	1.6	--	nC
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = -30V, V_{GS} = -10V, I_D = -1A, R_{GEN} = 6\Omega$	--	12	--	ns
Turn-on Rise Time	t_r		--	4	--	ns
Turn-off Delay Time	$t_{d(off)}$		--	38	--	ns
Turn-Off Fall Time	t_f		--	12	--	ns
Dynamic						
Input Capacitance	C_{iss}	$V_{DS} = -30V, V_{GS} = 0V, f = 1.0\text{MHz}$	--	885	--	pF
Output Capacitance	C_{oss}		--	85	--	pF
Reverse Transfer Capacitance	C_{rss}		--	80	--	pF

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C: The current rating is based on the $t_s \leq 10\text{s}$ junction to ambient thermal resistance rating.

RATING AND CHARACTERISTICS CURVES (RM4688S8)

N-Channel

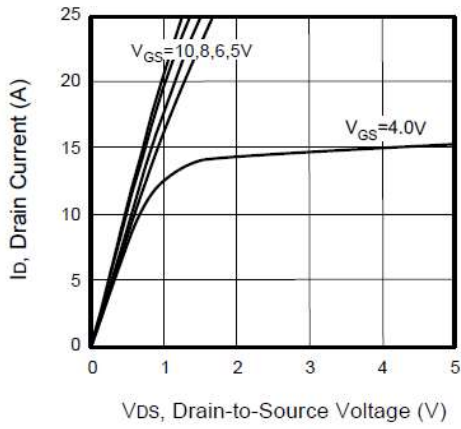


Figure 1. Output Characteristics

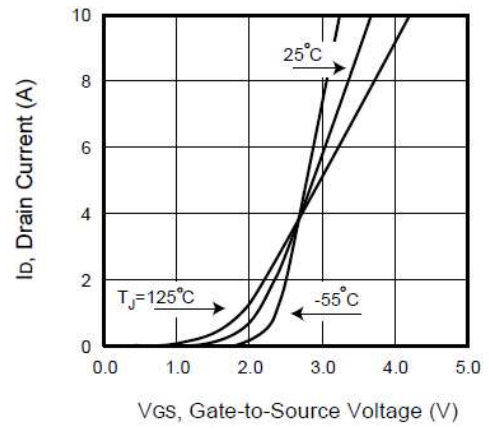


Figure 2. Transfer Characteristics

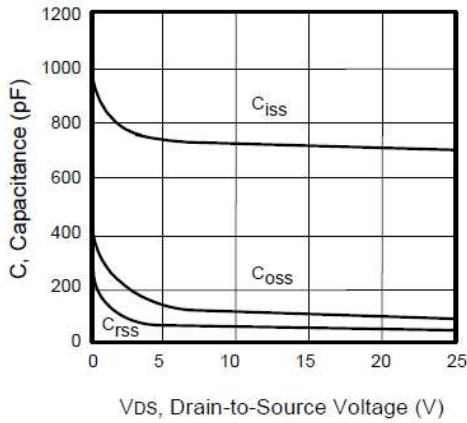


Figure 3. Capacitance

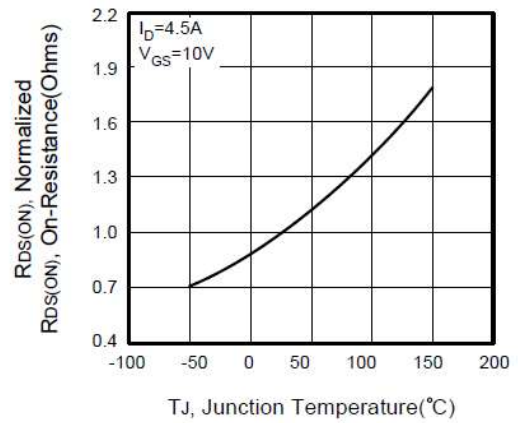


Figure 4. On-Resistance Variation with Temperature

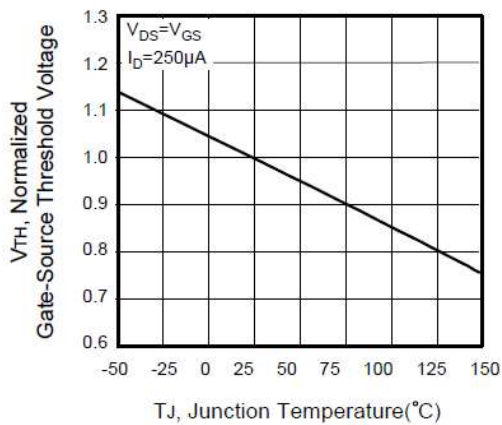


Figure 5. Gate Threshold Variation with Temperature

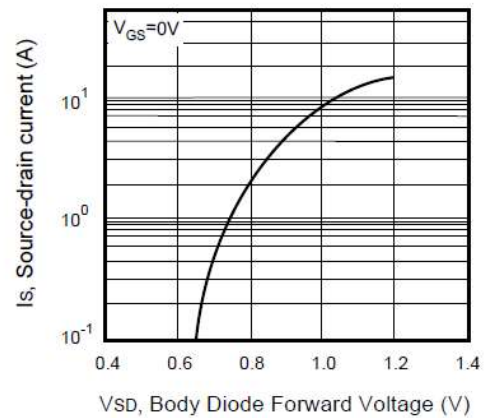


Figure 6. Body Diode Forward Voltage Variation with Source Current

RATING AND CHARACTERISTICS CURVES (RM4688S8)

P-Channel

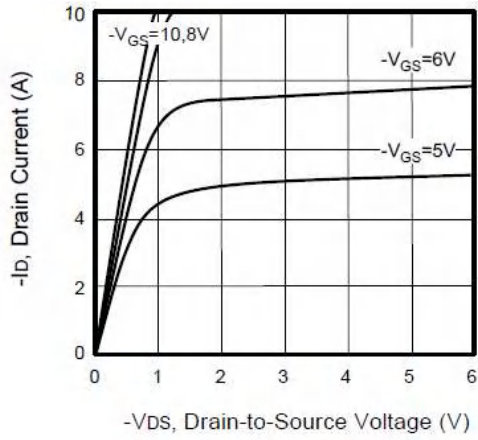


Figure 1. Output Characteristics

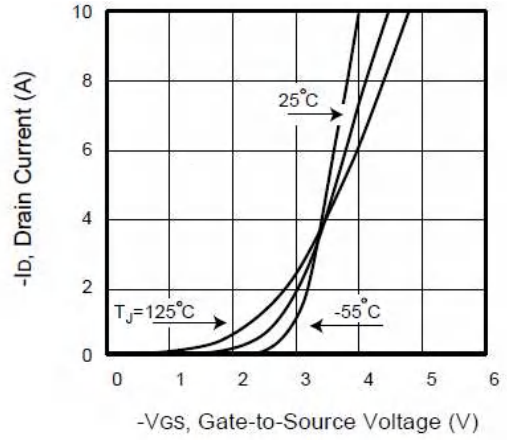


Figure 2. Transfer Characteristics

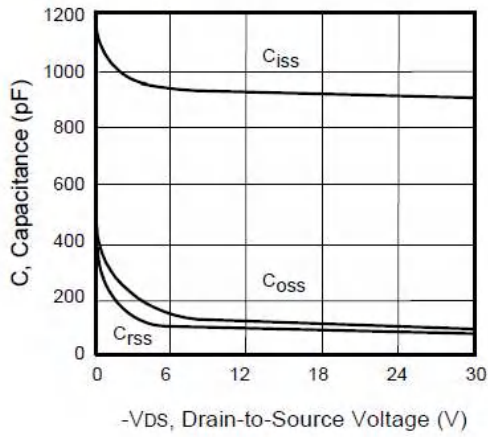


Figure 3. Capacitance

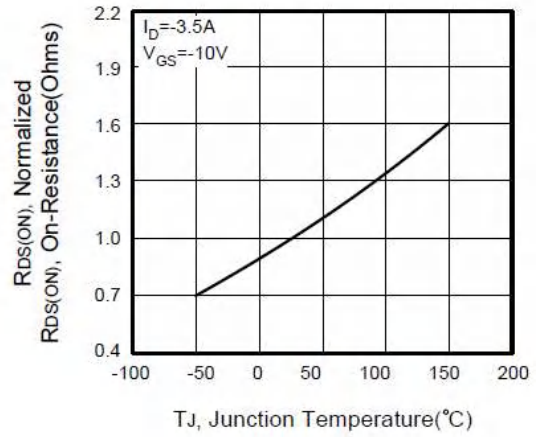


Figure 4. On-Resistance Variation with Temperature

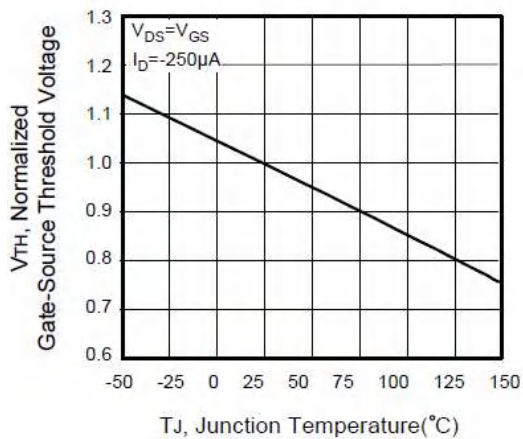


Figure 5. Gate Threshold Variation with Temperature

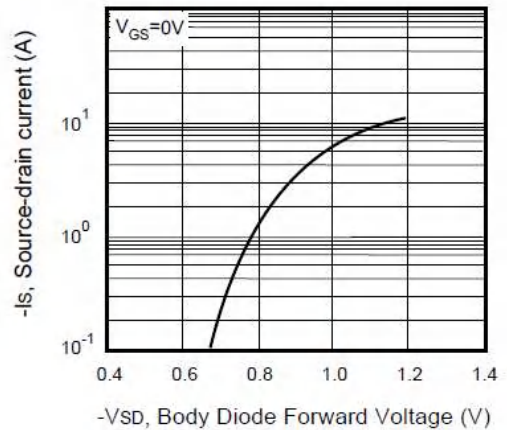


Figure 6. Body Diode Forward Voltage Variation with Source Current

RATING AND CHARACTERISTICS CURVES (RM4688S8)

N-Channel

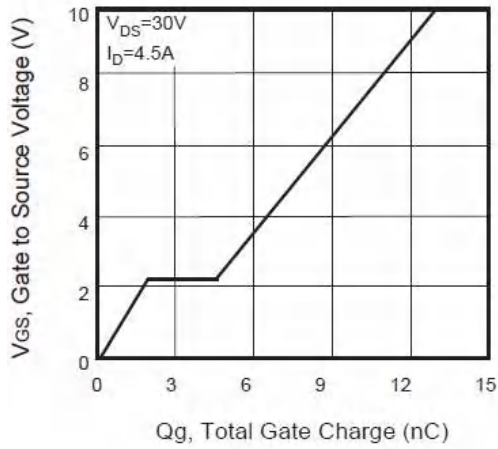


Figure 13. Gate Charge

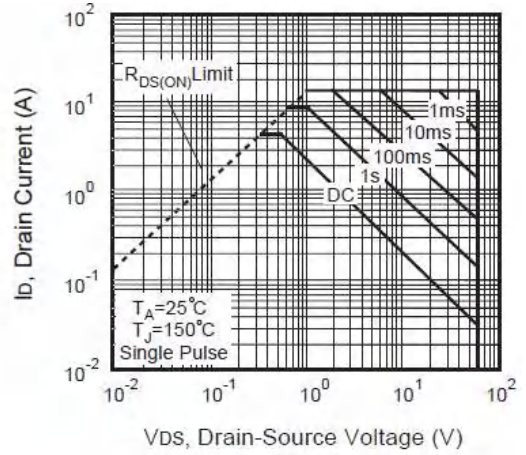


Figure 14. Maximum Safe Operating Area

P-Channel

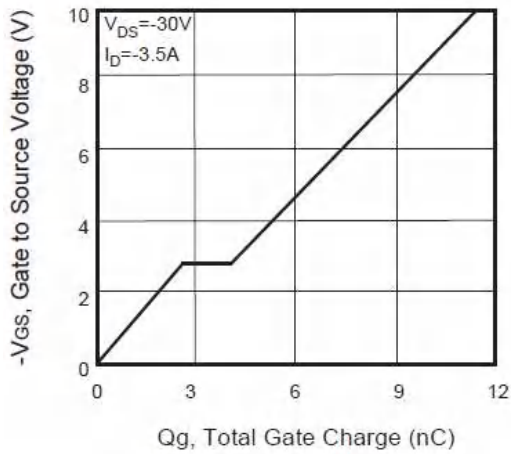


Figure 15. Gate Charge

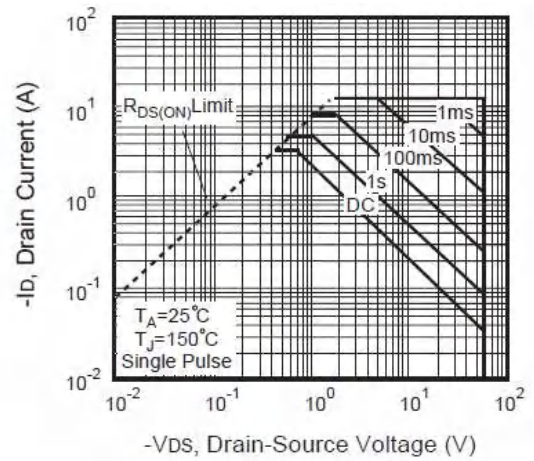


Figure 16. Maximum Safe Operating Area

RATING AND CHARACTERISTICS CURVES (RM4688S8)

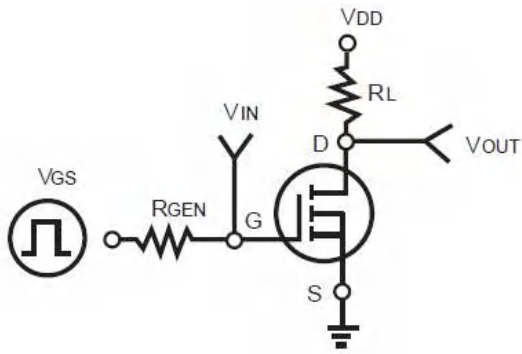


Figure 17. Switching Test Circuit

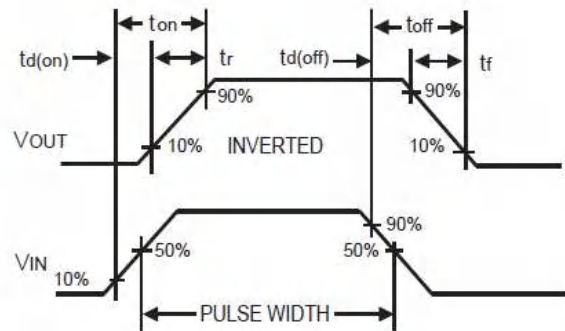


Figure 18. Switching Waveforms

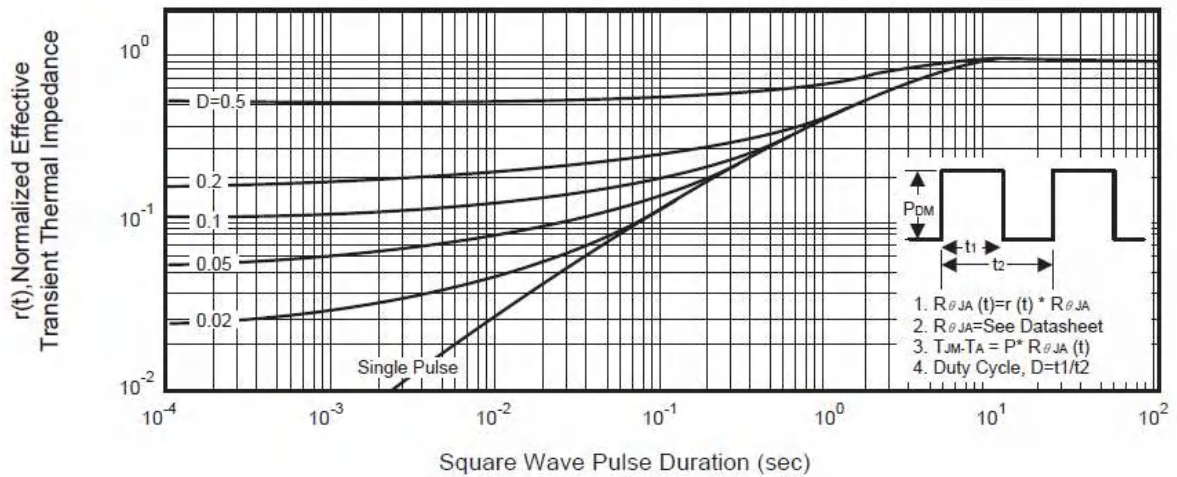
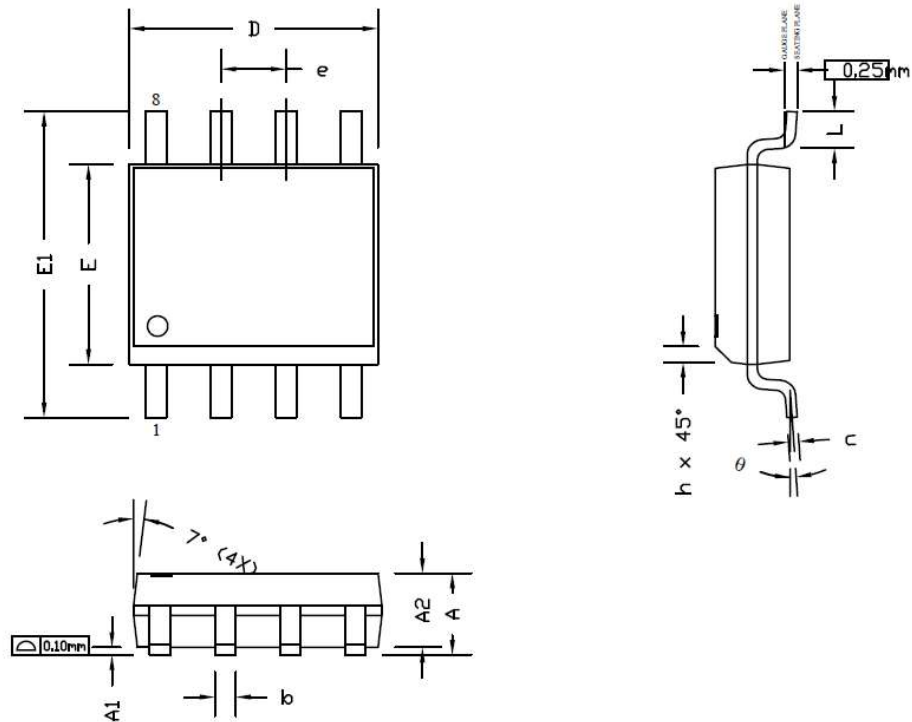
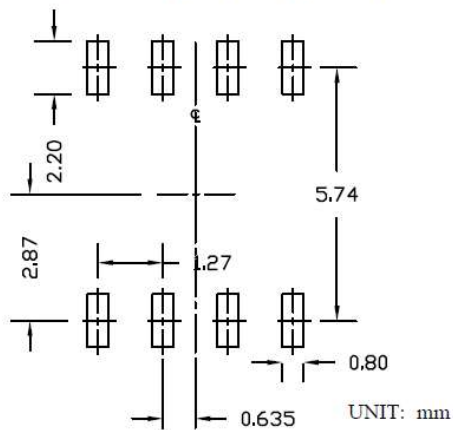


Figure 19. Normalized Thermal Transient Impedance Curve

Package Information



RECOMMENDED LAND PATTERN



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.35	1.65	1.75	0.053	0.065	0.069
A1	0.10	0.15	0.25	0.004	0.006	0.010
A2	1.25	1.50	1.65	0.049	0.059	0.065
b	0.31	0.41	0.51	0.012	0.016	0.020
c	0.17	0.20	0.25	0.007	0.008	0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E	3.80	3.90	4.00	0.150	0.154	0.157
e	1.27 BSC			0.050 BSC		
E1	5.80	6.00	6.20	0.228	0.236	0.244
h	0.25	0.30	0.50	0.010	0.012	0.020
L	0.40	0.69	1.27	0.016	0.027	0.050
θ	0°	4°	8°	0°	4°	8°

NOTE

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONS ARE INCLUSIVE OF PLATING.
3. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
4. DIMENSION L IS MEASURED IN GAUGE PLANE.
5. CONTROLLING DIMENSION IS MILLIMETER.
CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

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